

**RoHS** **Pb** **SL1011A/B and SL1411A Series**



**Description**

The SL1011A/B and SL1411A series provides high levels of protection against fast rising transients in the 100V/μs to 1kV/μs range usually caused by lightning disturbances.

The SL1011A/B and SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1011B and SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @ 8/20μs).

**Agency Approvals**

AGENCY	AGENCY FILE NUMBER
	E128662

**2 Electrode GDT Graphical Symbol**



**Features**

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1011B & SL1411A) surge capability tested with 8/20μs pulse as defined by IEC 61000-4-5

**Applications**

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

### Electrical Characteristics

Part Number	Device Specifications (at 25°C)								Life Ratings						
	DC Breakdown in Volts <sup>1,2</sup> (@100V/s)			Impulse Breakdown in Volts <sup>3</sup> (@100V/μs)	Impulse Breakdown In Volts (@1kV/μs)	Insulation Resistance	Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000μs)	Nominal Impulse Discharge Current (8/20μs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Discharge Current (9 Cycles @ 50Hz)	DC Holdover Voltage <sup>4</sup>	Max Impulse Discharge Current (1 Application)	
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 8/20μs	@ 10/350μs
SL1011A075	60	75	90	500	700	10 <sup>10</sup> Ω (at 50V)	1.5 pF	~20 V	300 shots	SL1011A: 10 shots (@5kA)	SL1011A: 5 A	SL1011A: 20 A	50 V	SL1011B & SL1411A: 12 kA	1 kA
SL1011B075															
SL1411A075															
SL1011A090	72	90	108	500	600	10 <sup>10</sup> Ω (at 100V)									
SL1011B090															
SL1411A090															
SL1011A145	116	145	174	500	650										
SL1011B145															
SL1011A150															
SL1011B150	120	150	180	500	650										
SL1011A230															
SL1011B230															
SL1411A230	184	230	276	550	700										
SL1011A250															
SL1011B250															
SL1411A250	200	250	300	600	800										
SL1011A260															
SL1011B260															
SL1011A350				600	800										
SL1011B350															
SL1411A350															
SL1011A470	280	350	420	800	900										
SL1011B350															
SL1411A350															
SL1411A350	376	470	564	1000	1100										
SL1011A470															
SL1411A470															
SL1011A500	400	500	600	1100	1200										
SL1011A600															
SL1411A600															
SL1411A600	480	600	720	1200	1400										

#### Notes:

1. At delivery AQL 0.65 level II, DIN ISO 2859
2. In ionized mode
3. Comparable to the silicon measurement Switching Voltage (Vs)
4. Tested according to ITU-T Rec. K.12 < 150 msecs.

### Product Characteristics

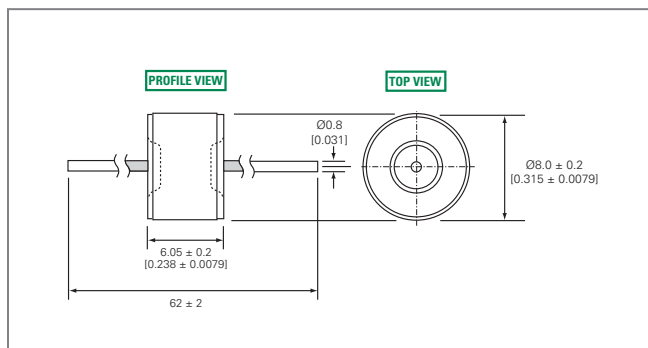
<b>Materials</b>	<b>Leaded Device:</b> Nickel-plated with Tin-plated wires <b>Core and Surface Mount:</b> Dull Tin-plated
<b>Product Marking</b>	Littelfuse 'LF' Mark, voltage and date code

<b>Glow to Arc Transition Current</b>	< 0.5 Amps
<b>Glow Voltage</b>	~60 Volts
<b>Storage and Operational Temperature</b>	-40 to +90°C

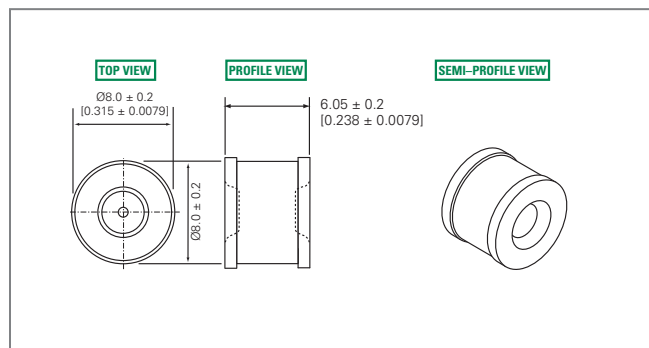
### Device Dimensions

For SL1011A/SL1011B series:

#### 'A' Type Axial Lead Devices

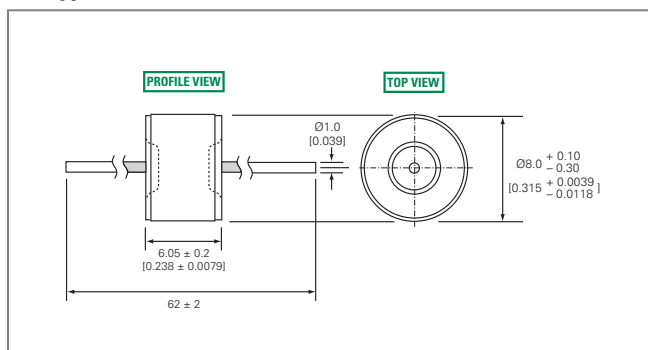


#### 'C' Type Core Devices

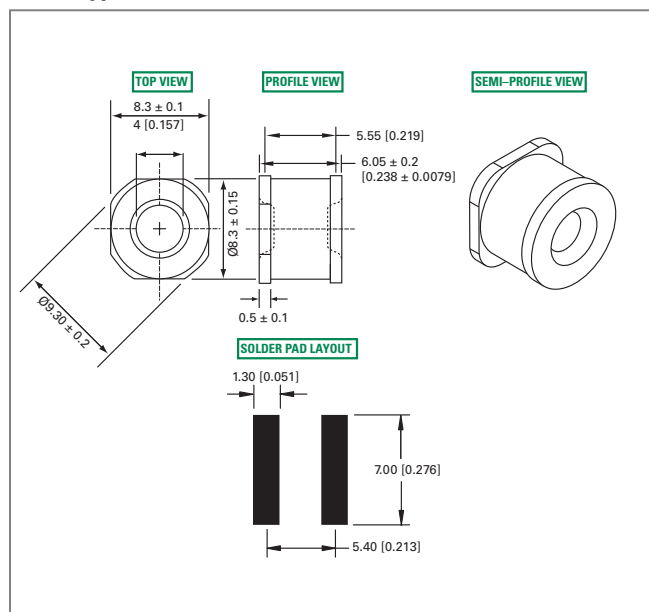


For SL1411A series:

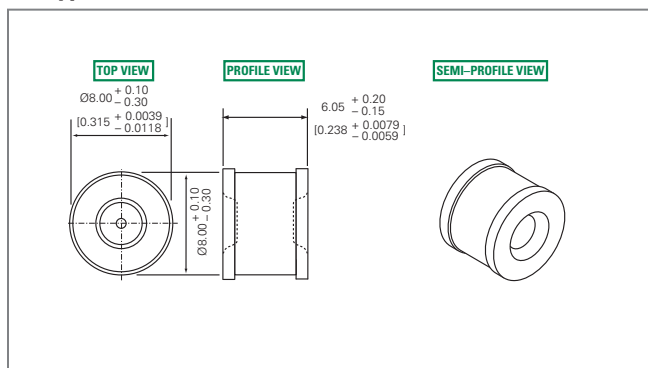
#### 'A' Type Axial Lead Devices



#### 'SM' Type Surface Mount Devices

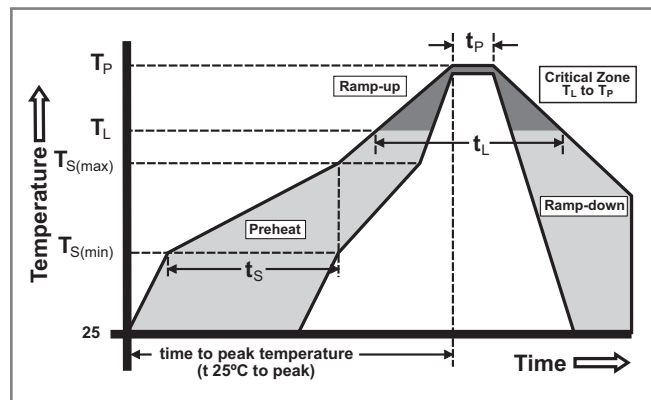


#### 'C' Type Core Devices

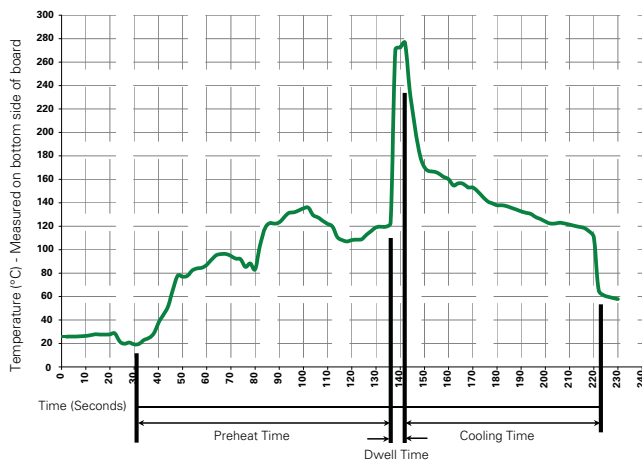


### Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Condition		Pb-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (Min to Max) ( $t_s$ )	60 – 180 seconds
Average Ramp-up Rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max.
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		5°C/second max.
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Temperature ( $t_L$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of Actual Peak Temperature ( $t_p$ )		10 – 30 seconds
Ramp-down Rate		6°C/second max.
Time 25°C to Peak Temperature ( $T_p$ )		8 minutes max.
Do not exceed		260°C



### Soldering Parameters - Wave Soldering (Thru-Hole Devices)



### Recommended Process Parameters:

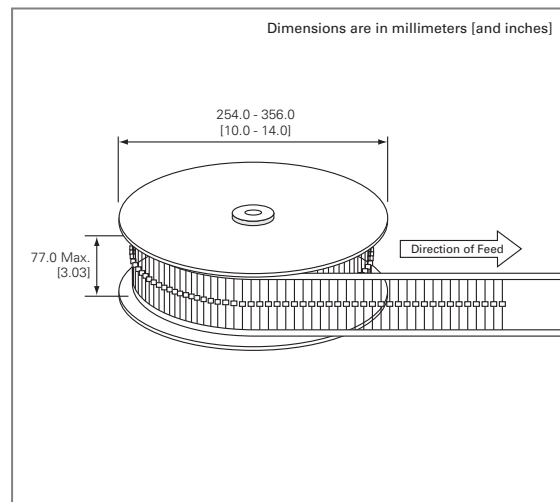
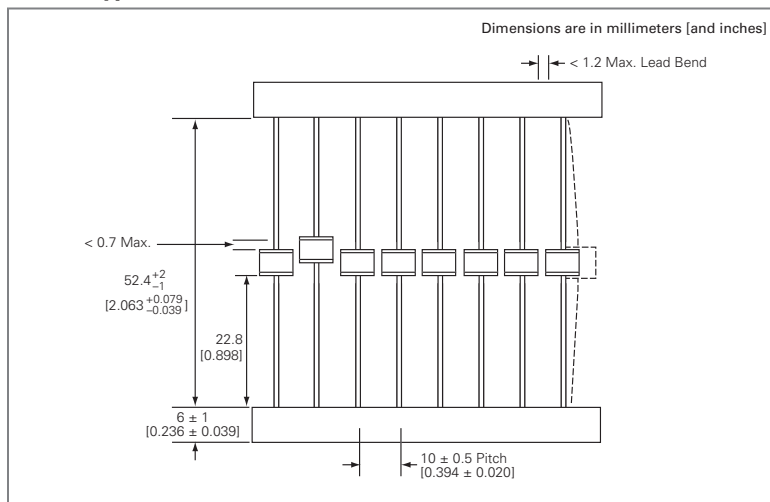
Wave Parameter	Lead-Free Recommendation
<b>Preheat:</b> (Depends on Flux Activation Temperature) (Typical Industry Recommendation)	
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	280° C Maximum
Solder Dwell Time:	2-5 seconds

### Soldering Parameters - Hand Soldering

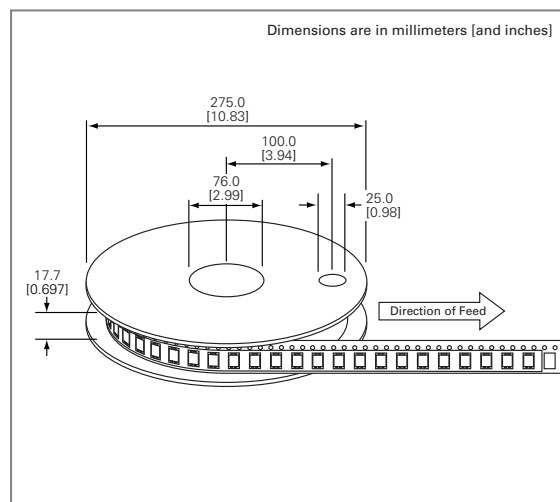
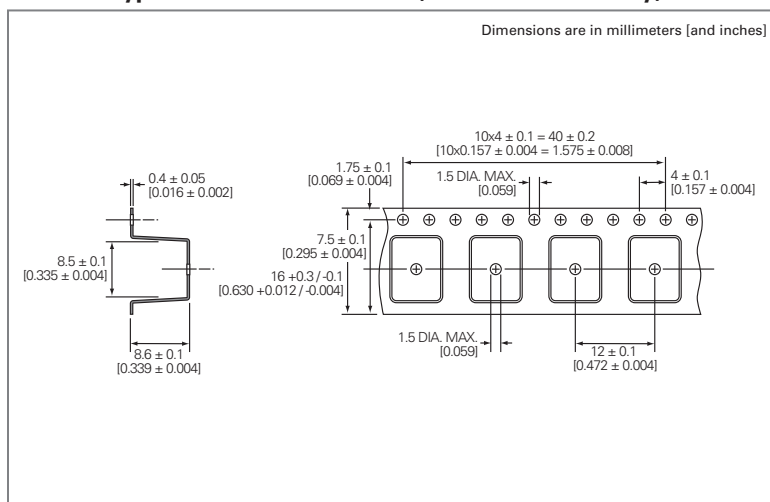
Solder Iron Temperature: 350° C +/- 5°C  
Heating Time: 5 seconds max.

## Packaging Dimensions

### For 'A' Type Axial Lead Items



### For 'SM' Type Surface Mount Items (SL1411A series only)



### For 'C' Type Core Items: Packed in plastic bag (500 pcs)

### Part Numbering System and Ordering Information

#### For SL1011A series:

**SL1011A XXX X**

**Voltage** ————

**Pin Configuration** ————

A = Axial Lead  
C = Core

Remarks: Formed leads are available on request

#### For SL1011B series:

**SL1011B XXX X**

**Voltage** ————

**Pin Configuration** ————

A = Axial Lead  
C = Core

Remarks: Formed leads are available on request

#### For SL1411A series:

**SL1411 A XXX XX**

**Surge Capability** ————

**Voltage** ————

**Pin Configuration** ————

A = Axial Lead  
C = Core  
SM = Surface Mount